

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: V8P20-M3/87A

Manufacturer: Vishay General Semiconductor - Diodes Division

Package: TO-277, 3-PowerDFN

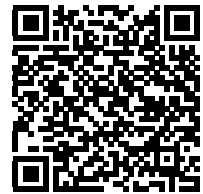
Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/vishay-general-semiconductor-diodes-division/v8p20-m3-87a.html>

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Contact Information

Email: info@antrexco.com

WhatsApp: +86-186-8066-5326

Website: <https://antrexco.com>

Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.60\text{ V}$ at $I_F = 4\text{ A}$



LINKS TO ADDITIONAL RESOURCES



FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8.0 A
V_{RRM}	200 V
I_{FSM}	150 A
V_F at $I_F = 8.0\text{ A}$	0.68 V
T_J max.	150 °C
Package	SMPC (TO-277A)
Circuit configuration	Single

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V8P20	UNIT
Device marking code		V820	
Maximum repetitive peak reverse voltage	V_{RRM}	200	V
Maximum average forward rectified current (fig. 1)	$I_F^{(1)}$	8.0	A
	$I_F^{(2)}$	2.2	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	150	A
Voltage rate of change (rated V_R)	dV/dt	10 000	V/ μ s
Operating junction and storage temperature range	T_J, T_{STG}	-40 to +150	°C

Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4 A	T _A = 25 °C	V _F ⁽¹⁾	0.80	-	V
	I _F = 8 A			0.95	1.40	
	I _F = 4 A	T _A = 125 °C		0.60	-	
	I _F = 8 A			0.68	0.76	
Reverse current	V _R = 180 V	T _A = 25 °C	I _R ⁽²⁾	2.0	-	μA
		T _A = 125 °C		2.1	-	mA
	V _R = 200 V	T _A = 25 °C		6.4	250	μA
		T _A = 125 °C		3.4	20	mA

Notes(1) Pulse test: 300 μs pulse width, 1 % duty cycle(2) Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V8P20	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	80	$^{\circ}\text{C/W}$
	$R_{\theta JM}^{(2)}$	4	

Notes(1) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient(2) Mounted on 30 mm x 30 mm Al PCB; thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V8P20-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
V8P20-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel

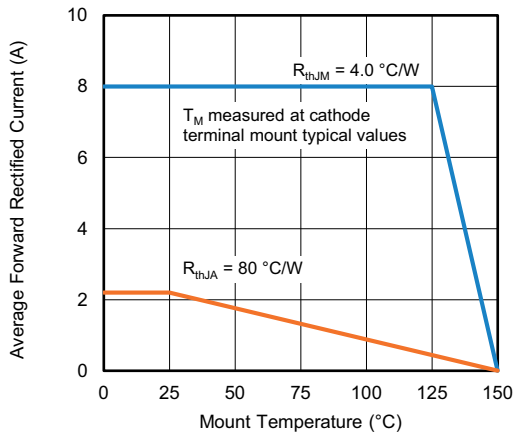
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

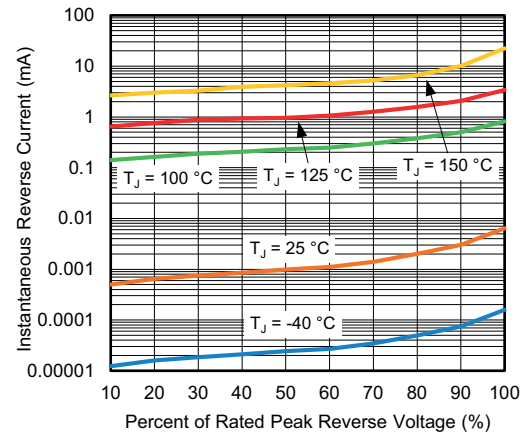


Fig. 4 - Typical Reverse Characteristics

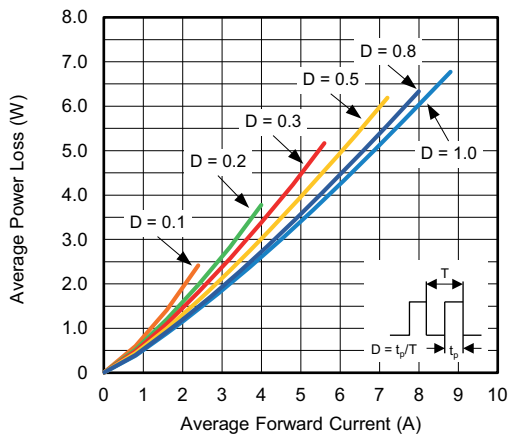


Fig. 2 - Forward Power Loss Characteristics

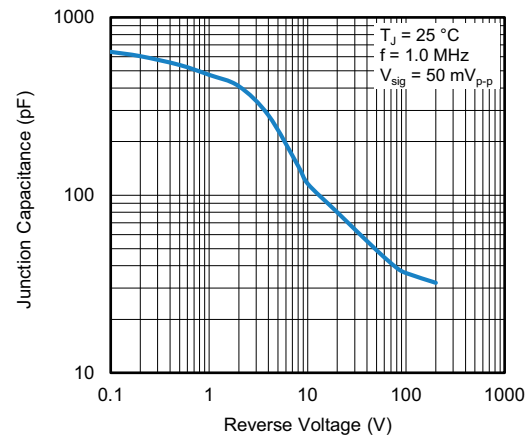


Fig. 5 - Typical Junction Capacitance

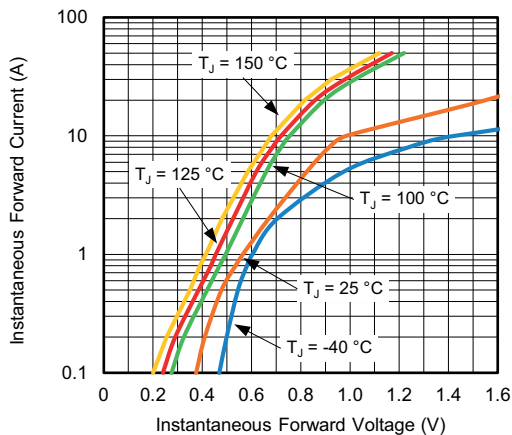


Fig. 3 - Typical Instantaneous Forward Characteristics

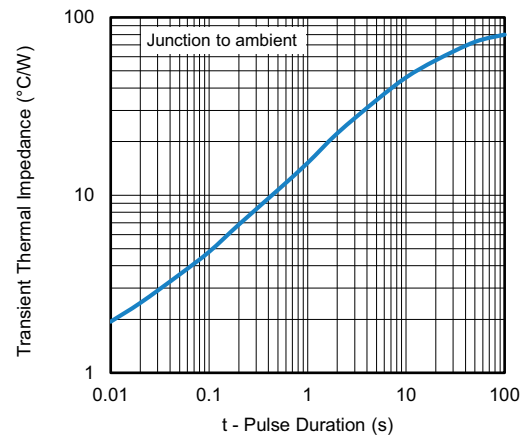
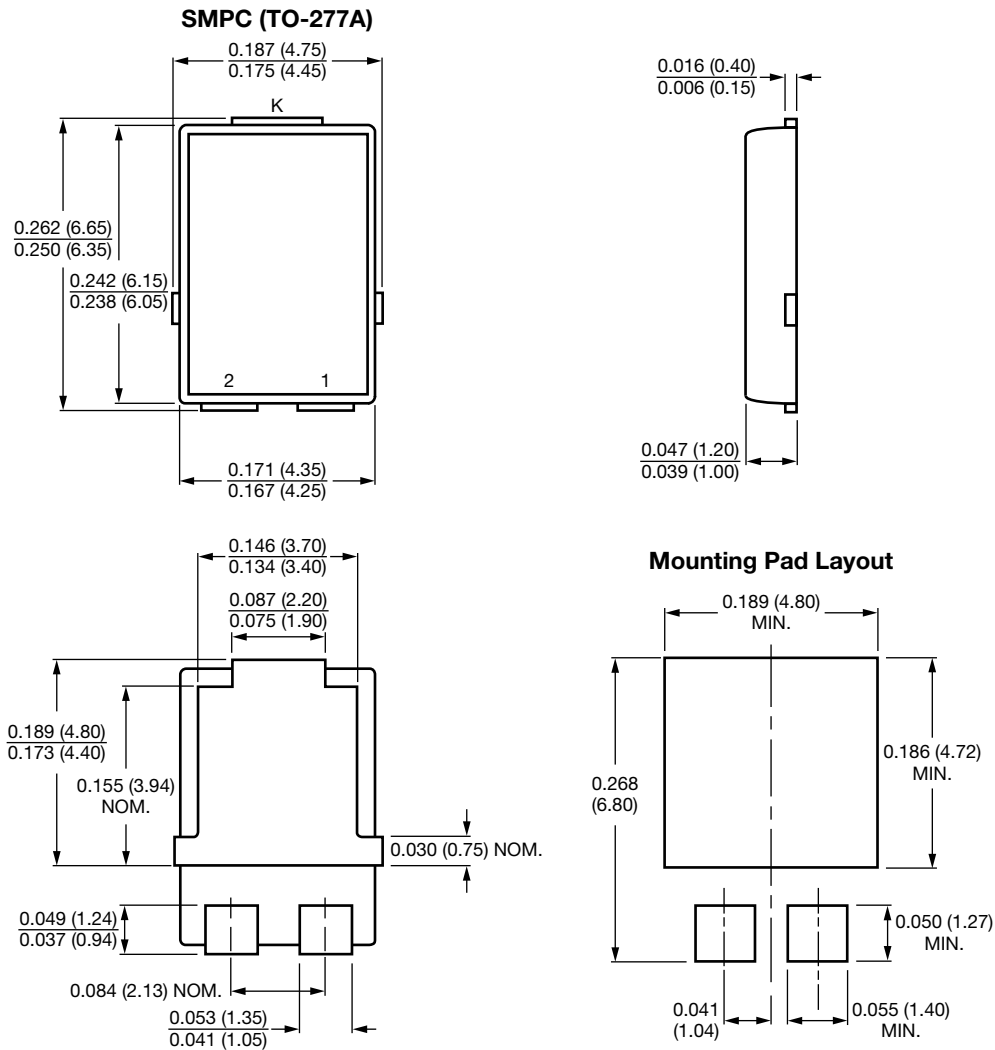


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)


Conform to JEDEC® TO-277A



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